

Call For Abstracts

The 20th International Conference on the Physical Properties and Application of Advanced Materials (ICPMAT 2026)



in conjunction
with

The 2nd International Conference on Advanced Materials and Technologies (ICAMT 2026)

Date & Venue

July 23-25, 2026

**Hanoi University of Science and Technology
No.1, Dai Co Viet street, Bach Mai, Hanoi, Vietnam.**

**1st
Announcement**

Introduction

The International Conference on the Physical Properties and Application of Advanced Materials (ICPMAT) is an annual conference founded by the University of Toyama (Japan) and the Japan Institute of Metals, and organized within an international network including Kyungpook National University (Republic of Korea), Shandong University (China), Chiang Mai University (Thailand), Hanoi University of Science and Technology (Vietnam), and European partners such as the Technical University of Košice (Slovakia), AGH University of Science and Technology (Poland), and the Norwegian University of Science and Technology. The conference focuses on fundamental and applied research in physics and materials science.

The International Conference on Advanced Materials and Technologies (ICAMT), initiated by the School of Materials Science and Engineering, Hanoi University of Science and Technology, will be jointly organized with ICPMAT in 2026 to enhance international impact. The ICPMAT & ICAMT 2026 conference will take place at Hanoi University of Science and Technology, Hanoi, Vietnam, from July 23rd to 25th, 2026, providing a platform for global collaboration in materials science and advanced technologies.

Topics

- Metallurgical Engineering
- Structural Materials (Light metals, Steels, Deformation, etc.)
- Functional Materials (Superconductors, Oxides, Ceramics, Composites, Spintronics, Energy-related materials, Nanomaterials, etc.)
- Computational Materials Science (Finite Element Methods, Density Functional Theory, MC, etc.)
- Materials related technology

Important Dates

- **Opening of Abstract Submission and Registration**
Mar 1, 2026
- **Deadline for abstract submission**
May 31, 2026
- **Abstract acceptance notice**
Jun 15, 2026
- **Early Bird Registration Deadline**
Jun 21, 2026
- **Deadline for paper submission**
Jun 30, 2026
- **Conference**
July 23-25, 2026

Registration Fee

- **PRESENTER \$400**
- **STUDENT \$200**

The fee covers the attendance at the conference sessions, conference package, documentation, coffee breaks, lunches and banquet. However, accommodation charge and breakfast are not included.

Publication Opportunity

Selected papers invited to submit to **Materials Science Forum** or **Key Engineering Materials** with SCOPUS indexed (publication fee 80€/paper).

Submission Link

<https://icpmat-icamt.hust.edu.vn/>

Supported by



Academic and social program (tentative)

Wednesday, 22 July

Registration

Thursday, 23 July

Oral presentations

Lunch

Conference Banquet

Friday, 24 July

Oral presentations

Poster session

Lunch

Dinner

Saturday, 25 July

Technical Tour (around 1 day)

Sunday, 26 July

Departure

Chairperson



Huynh Trung Hai

Hanoi University of Science
and Technology, Vietnam

Co-Chairpersons



Yutaka Takaguchi

University of Toyama,
Japan



Injoon Son

Kyungpook National
University, Korea



Nguyen Duc Hoa

Hanoi University of Science
and Technology, Vietnam



Pham Mai Khanh

Hanoi University of Science
and Technology, Vietnam



Chunjoong Kim

Chungnam National
University, Korea

Organizing Committee

K. Matsuda – University of Toyama, Japan

S. W. Lee – University of Toyama, Japan

H. Ono – University of Toyama, Japan

T. Shibayanagi – University of Toyama, Japan

N. Nunomura – University of Toyama, Japan

T. Aida – University of Toyama, Japan

M. Yoshida – University of Toyama, Japan

T. Yamane – University of Toyama, Japan

T. Namiki – University of Toyama, Japan

H. Mashahiko – University of Toyama, Japan

T. Tsuchiya – University of Toyama, Japan

I. J. Son – Kyungpook National University, Korea

H. S. Lee – Kyungpook National University, Korea

S. H. Park – Kyungpook National University, Korea

S. E. Chun - Kyungpook National University, Korea

Y. Min – Kyungpook National University, Korea

K. I. Park – Kyungpook National University, Korea

I. Han – Kyungpook National University, Korea

S. W. Lee – Kyungpook National University

J. H. Lee – Kyungpook National University

R. B. K. Chung - Kyungpook National University

Y. M. Jo – Kyungpook National University

S. C. Kim – Kyungpook National University

Y. Zou – Shandong University, China

G. H. Min – Shandong University, China

P. C. Si – Shandong University, China

I. Mullerova – The Czech Academy of Sciences, Brno, Czech Republic

R. Holmestad – Norwegian University of Science and Technology, Norway

M. Lewandowska – Warsaw University of Technology, Poland

M. Stygar – AGH University of Science and Technology, Poland

C. Banjongprasert – Chiang Mai University, Thailand

K. Pimraksa – Chiang Mai University, Thailand

G. J. Shiflet – University of Virginia, USA

M. Murayama – Virginia Tech, USA

N. T. Liem – Hanoi University of Science and Technology (HUST), Vietnam

L. T. Hung – Hanoi University of Science and Technology, Vietnam

N. P. Duong – Hanoi University of Science and Technology, Vietnam

D. A. Vu – Hanoi University of Science and Technology, Vietnam

B. A. Hoa – Hanoi University of Science and Technology, Vietnam

N. V. Quy – Hanoi University of Science and Technology, Vietnam

P. T. Thao – Hanoi University of Science and Technology, Vietnam

P. A. Tuan – Hanoi University of Science and Technology, Vietnam

N. H. Viet – Hanoi University of Science and Technology, Vietnam

P. H. Vuong – Hanoi University of Science and Technology, Vietnam

T. D. Lam, Institute of Materials Science, Vietnam Academy of Science
and Technology (VAST), Vietnam

N. Q. Anh, Institute of Chemistry, Vietnam Academy of Science and
Technology (VAST), Vietnam

C. K. Son, School of Chemical and Life Sciences, HUST, Vietnam

N. H. Lam, Faculty of Engineering physics, HUST, Vietnam

N.T. Chung, Faculty of Mechanical Engineering, Le Quy Don University, Vietnam

D.V. Duong, Phenikaa University, Vietnam

L. A. Tuan, Phenikaa University, Vietnam

N. V. Hieu, Phenikaa University, Vietnam

N. N. Dinh, Hanoi University of Science, VNU, Vietnam

N. D. Nam. Vietnam Maritime University, VMU, Vietnam

To be updated

Secretary board

N. H. Viet – Hanoi University of Science and Technology (General
Secretary), Vietnam

T. V. Trung – Hanoi University of Science and Technology, Vietnam

L. T. Bang – Hanoi University of Science and Technology, Vietnam

H. M. Tan – Hanoi University of Science and Technology, Vietnam

N. H. Anh – Hanoi University of Science and Technology, Vietnam

D.T.T. Nguyet – Hanoi University of Science and Technology, Vietnam

To be updated